



PATENT

In re application of:

MUNEKATA ET AL

Serial No.: 10/666,129

Art Unit: 1742

Filed: September 22, 2003 Examiner: Sikyin Ip

For: LEAD-FREE SOLDER ALLOY

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

A preliminary amendment in the above-identified patent application is attached.

[X] No additional claim fee is required.

[] The claim fee has been calculated as shown below:

(Col. 1)		(Col. 2)		(Col. 3)	SMALL ENTITY		OTHER THAN A SMALL ENTITY	
////////	CLAIMS	////////	HIGHEST					
////////	REMAINING	////////	NO.					
////////	AFTER	////////	PREVIOUSLY	PRESENT		ADDIT.		ADDIT.
////////	AMENDMENT	////////	PAID FOR	EXTRA	RATE	FEE	RATE	FEE
TOTAL	* 20	MINUS	** 20	= 0	x 9=	\$	x 18=	\$ 0
INDEP	* 1	MINUS	*** 3	= 0	x 43=	\$	x 86=	\$ 0
FIRST PRESENTATION OF MULT. DEP. CLAIM					+145	\$	+290=	\$
					TOTAL	\$	TOTAL	\$ 0

* If entry in Col. 1 is less than that in Col. 2, write "0" in Col. 3.

** If the highest no. previously paid for IN THIS SPACE is less than 20, write "20" in this space.

*** If the highest no. previously paid for IN THIS SPACE is less than 3, write "3" in this space.

- [] Please charge Deposit Account No. 50-1079 in the amount of \$.
- [] A check in the amount of \$ is attached.
- [] The Commissioner is authorized to charge any deficiency in the following fees associated with this communication and to credit any excess payment to Deposit Account No. 50-1079. A duplicate copy of this letter is attached.
- [] Any filing fees pursuant to 37 CFR §1.16 for the presentation of extra claims.
- [] Any patent application processing fees pursuant to 37 CFR §1.17, including extension of time fees pursuant to 37 CFR §1.17(a)-(d).

Respectfully submitted,



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Date: Jan 27, 2004



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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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MUNEKATA ET AL

Application No.: 10/666,129

Art Unit: 1742

Filed: September 22, 2003

Examiner: Sikyin Ip

For: LEAD-FREE SOLDER ALLOY

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Prior to examination, please amend the present application
as shown below.